

BYC20-600 Rectifier diode, hyperfast Rev. 01 — 28 August 2018

Product data sheet

Product profile 1.

1.1 General description

Hyperfast, epitaxial rectifier diode in a SOD59 (2-lead TO-220AC) plastic package.

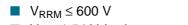
1.2 Features

- Extremely fast switching Reduces switching loss in associated
- Low thermal resistance Low reverse recovery current
- MOSFET

1.3 Applications

■ Half-bridge or full-bridge switched-mode ■ Continuous Current Mode (CCM) Power Factor Correction (PFC) power supplies Half-bridge lighting ballasts

1.4 Quick reference data



V_F = 1.54 V (typ)

I_{F(AV)} ≤ 20 A ■ t_{rr} = 19 ns (typ)

Pinning information 2.

Table 1. Pinning

Pin	Description	Simplified outline	Symbol
1	cathode (k)	mb	
2	anode (a)		k — — — a <i>001aaa020</i>
mb	mounting base; cathode		

TO-220AC (SOD59)

3. Ordering information

Table 2. Ordering information					
Type number	Package				
	Name	Description	Version		
BYC20-600	TO-220AC	plastic single-ended package; heatsink mounted; 1 mounting hole; 2-lead TO-220AC	SOD59		

4. Limiting values

Table 3.Limiting values

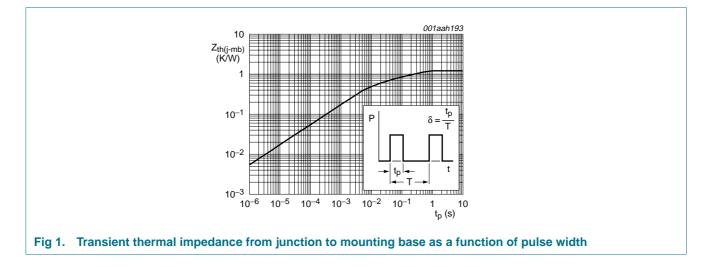
In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V _{RRM}	repetitive peak reverse voltage		-	600	V
V _{RWM}	crest working reverse voltage		-	600	V
V _R	reverse voltage	square waveform; δ = 1.0; T_{mb} \leq 100 $^{\circ}C$	-	500	V
I _{F(AV)}	average forward current	square waveform; δ = 0.5; T_{mb} \leq 93 $^{\circ}C$	-	20	А
I _{FRM}	repetitive peak forward current	square waveform; δ = 0.5; T_{mb} \leq 93 °C; t_p = 25 μ s;	-	40	А
I _{FSM}	non-repetitive peak forward	t = 10 ms; sinusoidal waveform	-	250	А
	current	t = 8.3 ms; sinusoidal waveform	-	274	А
T _{stg}	storage temperature		-40	+150	°C
Тj	junction temperature		-	150	°C
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5. Thermal characteristics

Table 4.	Thermal characteristics					
Symbol	Parameter	Conditions	Min	Тур	Мах	Unit
R _{th(j-mb)}	thermal resistance from junction to mounting base	with heatsink compound; see <u>Figure 1</u>	-	-	1.2	K/W
R _{th(j-a)}	thermal resistance from junction to ambient	in free air	-	60	-	K/W



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6. **Characteristics**

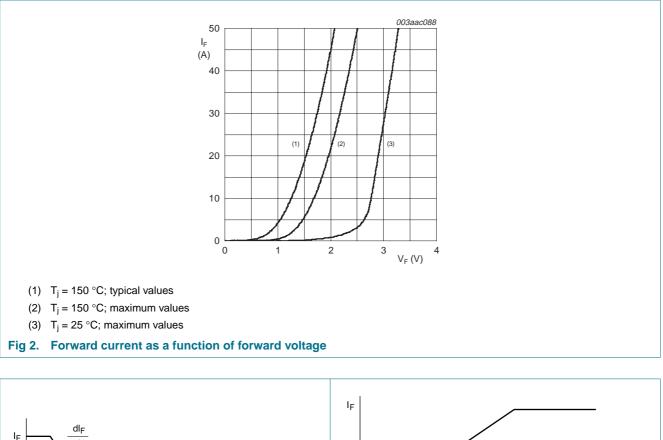
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static cha	racteristics					
V _F	forward voltage	$I_F = 20 \text{ A}; T_j = 150 \text{ °C}; \text{ see } \frac{\text{Figure 2}}{2}$	-	1.54	1.97	V
		$I_F = 40 \text{ A}; T_j = 150 \text{ °C}; \text{ see } \frac{\text{Figure 2}}{\text{Figure 2}}$	-	1.95	2.34	V
		I _F = 20 A; see <u>Figure 2</u>	-	1.89	2.9	V
I _R	reverse current	V _R = 600 V	-	16	200	μA
		$V_R = 500 \text{ V}; \text{ T}_j = 100 ^{\circ}\text{C}$	-	1.6	3.0	mA
Dynamic o	haracteristics					
t _{rr}	reverse recovery time	$I_F = 1 \text{ A to } V_R = 30 \text{ V}; \text{ d}_F/\text{d}t = 50 \text{ A}/\mu\text{s};$ see Figure 3	-	35	55	ns
		I _F = 20 A to V _R = 400 V; dI _F /dt = 500 A/μs; see <u>Figure 3</u>				
		T _j = 25 °C	-	19	-	ns
		T _j = 100 °C	-	32	40	ns
I _{RM}	peak reverse recovery current	$I_F = 20 \text{ A to } V_R = 400 \text{ V}; T_j = 125 \text{ °C};$ see Figure 3				
		$dI_F/dt = 50 A/\mu s$	-	3.0	7.5	А
		$dI_F/dt = 500 \text{ A}/\mu \text{s}$	-	9.5	12	А
V _{FR}	forward recovery voltage	I _F = 20 A; dI _F /dt = 100 A/μs; see Figure 4	-	8	11	V

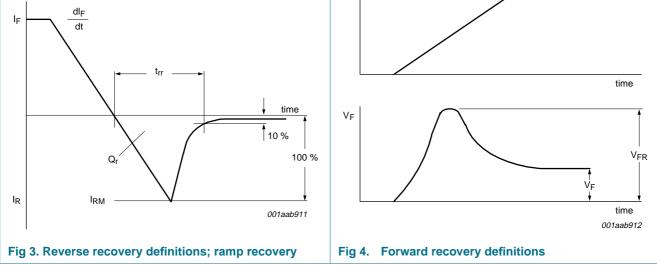
Table 5 Characteristics

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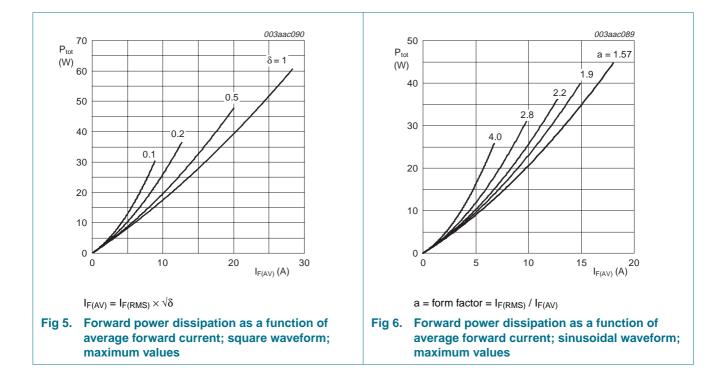


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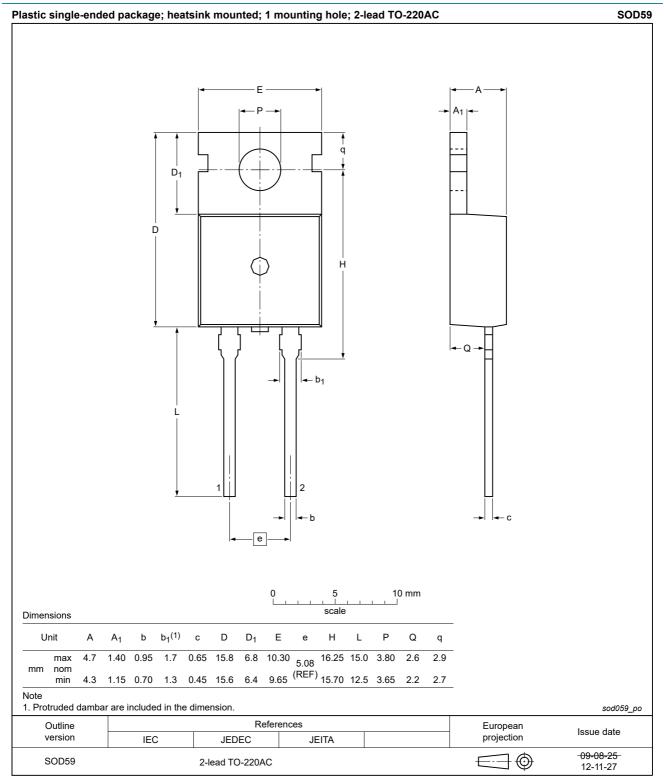


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7. Package outline



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8. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

- [2] The term 'short data sheet' is explained in section "Definitions".
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